## DRAFT U.S. Module Assembly Responsibilities

FE ICs		<b>Detectors</b>		Flex Hybrid	
Fab	LBL	Fab	New Mexico	Fab	Oklahoma
Ship	LBL	Ship	New Mexico	Inspect(in fab)	Oklahoma
Probe	LBL	Probe	New Mexico	Ship	Oklahoma
Ship	LBL	Ship	New Mexico	Cut(in fab)	Oklahoma
Bump deposition		Bump deposition		Ship	Oklahoma
Ship		Ship		Probe(in fab)	Albany
Inspection(bump yield)		Inspection(bump yield)		Ship	Albany
Ship		Ship		Mount components	Oklahoma
Thin and metallize	LBL, if needed	Dice		Ship	Oklahoma
Ship	LBL, if needed	Sort		Wire bond	LBL
Dice	LBL, if needed	Ship		Ship	LBL
Sort	LBL, if needed	Inspect		Probe/burn-in	Albany, Oklahoma/LBL, if needed
Ship	LBL, if needed			Ship	Albany, Oklahoma/LBL, if needed
Inspect	LBL, if needed				
Optical Components		Module Assembly		Local Power Cabling	
IC fab	Ohio	Flip chip/die		Fab	LBL
IC Ship	Ohio	Flip chip/module		Inspect/Test	LBL
IC Probe	Ohio	Ship		Ship	LBL
IC Ship	Ohio	Inspect			
IC thin	Ohio, LBL if needed	Ship		MCC ICs	
IC dice	Ohio, LBL if needed	Probe bare module	LBL	Fab	
IC Ship	Ohio, LBL if needed	Ship	LBL	Ship	
Fiber fab	Ohio	Attach flex	LBL, others are TBD	Probe	
Fiber ship	Ohio	Wire bond(with repair)	LBL, others are TBD	Ship	
Fiber inspect/test	Ohio	Attach pwr/optics	LBL, others are TBD	Thin	LBL, if needed
Package fab	Ohio	Ship	LBL, others are TBD	Ship	LBL, if needed
Package ship	Ohio	Test/burn in	Albany, UNM, OSU, UOK	Dice	LBL, if needed
Package inspect/test	Ohio	Ship	Albany, UNM, OSU, UOK	Ship	LBL, if needed
Package ship	Ohio				
		<u>Database</u>			
		Requirements	LBL, New Mexico		
		Code development	LBL, New Mexico		
		Central hardware			
		Code support	LBL		